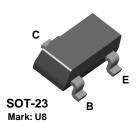


BSR14



NPN General Purpose Amplifier

This device is for use as a medium power amplifier and switch requiring collector currents up to 500 mA. Sourced from Process 19. See BCW65C for characteristics.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	75	V
V _{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector Current - Continuous	800	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		*BSR14	
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

^{*}Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

NPN General Purpose Amplifier

(continued)

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHAI	RACTERISTICS				
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \ \mu\text{A}, \ I_B = 0$	75		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	6.0		V
Ісво	Collector-Cutoff Current	V _{CB} = 60 V V _{CB} = 60 V, T _A = 150°C		10 10	nA μA
I _{CEX}	Collector-Cutoff Current	V _{CE} = 60 V, V _{EB} = 3.0 V		10	nA
I _{BEX}	Reverse Base Current	V _{CE} = 60 V, V _{EB} = 3.0 V		20	nA
I _{EBO}	Emitter-Cutoff Current	$V_{EB} = 3.0 \text{ V}, I_{C} = 0$		15	nA
h _{FE}	ACTERISTICS DC Current Gain	$I_C = 0.1 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$	35 50		
I FE	DC Current Gain	$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_C = 150 \text{ mA}, V_{CE} = 10 \text{ V}$	50 75 100	300	
.,	Oulle des Freites Out setting Valle	$I_C = 150 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_C = 500 \text{ mA}, V_{CE} = 10 \text{ V}$	50 40	0.0	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.3 1.0	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$	0.6	1.2 2.0	V V
SMALL SI	GNAL CHARACTERISTICS Current Gain - Bandwidth Product	I _C = 20 mA, V _{CE} = 20,	300		MHz
11		f = 100 mHz	000		1411 12
Ссв	Collector-Base Capacitance	V_{CB} = 10V, I_E = 0, f = 1.0 MHz		8.0	pF
h _{ie}	Input Impedance	V _{CE} =10V,I _C =1.0 mA,f=1.0 kHz	2.0	8.0	kΩ
h _{fe}	Small-Signal Current Gain	V _{CE} =10V,I _C =1.0 mA,f=1.0 kHz	50	300	
h _{oe}	Output Admittance	V _{CE} =10V,I _C =1.0 mA,f=1.0 kHz	5	35	μS
SWITCHIN	NG CHARACTERISTICS				
t _d	Delay Time	$V_{CC} = 30 \text{ V}, V_{BE(OFF)} = 0.5 \text{ V},$		10	ns
-u	Rise Time	$I_{\rm C} = 150 \text{ mA}, I_{\rm B1} = 15 \text{ mA}$		25	ns
-	Kise Tillie	, =:			
t _r	Storage Time	$V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA},$		225	ns

Spice Model

NPN (ls=14.34f Xti=3 Eg=1.11 Vaf=74.03 Bf=255.9 Ne=1.307 lse=14.34f lkf=.2847 Xtb=1.5 Br=6.092 Nc=2 lsc=0 lkr=0 Rc=1 Cjc=7.306p Mjc=.3416 Vjc=.75 Fc=.5 Cje=22.01p Mje=.377 Vje=.75 Tr=46.91n Tf=411.1p ltf=.6 Vtf=1.7 Xtf=3 Rb=10)

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